

## United States Patent and Trademark Office



UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/829,431	04/22/2004	Ching Man Tsui	033539-021	8776		
21839 7.	590 02/16/2006		EXAM	EXAMINER		
BUCHANAN	INGERSOLL PC	KOBERT, RUS	KOBERT, RUSSELL MARC			
(INCLUDING BURNS, DOANE, SWECKER & MATHIS) POST OFFICE BOX 1404 ALEXANDRIA, VA 22313-1404			ART UNIT	PAPER NUMBER		
			2829			
			DATE MAILED: 02/16/2006			

Please find below and/or attached an Office communication concerning this application or proceeding.

## Advisory Action Before the Filing of an Appeal Brief

Application No.	Applicant(s)
10/829,431	TSUI ET AL.
Examiner	Art Unit
Russell M. Kobert	2829

	Russell M. Kobert	2829	
The MAILING DATE of this communication appear	ars on the cover sheet with the	correspondence add	ress
THE REPLY FILED 30 January 2006 FAILS TO PLACE THIS A	PPLICATION IN CONDITION FOR	R ALLOWANCE.	
<ol> <li>The reply was filed after a final rejection, but prior to or on this application, applicant must timely file one of the follow places the application in condition for allowance; (2) a Not a Request for Continued Examination (RCE) in compliance time periods:</li> <li>The period for reply expires 3 months from the mailing date b)</li> <li>The period for reply expires on: (1) the mailing date of this A no event, however, will the statutory period for reply expire land.</li> </ol>	ving replies: (1) an amendment, aftice of Appeal (with appeal fee) in e with 37 CFR 1.114. The reply m of the final rejection.  dvisory Action, or (2) the date set fortheter than SIX MONTHS from the mailing.	fidavit, or other evider compliance with 37 Clust be filed within one in the final rejection, who date of the final rejecti	ce, which FR 41.31; or (3) of the following ichever is later. In on.
Examiner Note: If box 1 is checked, check either box (a) or ( TWO MONTHS OF THE FINAL REJECTION. See MPEP 70		E FIRST REPLT WAS F	ILED WITHIN
Extensions of time may be obtained under 37 CFR 1.136(a). The date have been filed is the date for purposes of determining the period of ext under 37 CFR 1.17(a) is calculated from: (1) the expiration date of the set forth in (b) above, if checked. Any reply received by the Office later may reduce any earned patent term adjustment. See 37 CFR 1.704(b). NOTICE OF APPEAL	on which the petition under 37 CFR 1. ension and the corresponding amount hortened statutory period for reply original three months after the mailing date.	of the fee. The appropri pinally set in the final Offi ate of the final rejection, o	ate extension fee ce action; or (2) as even if timely filed,
<ol> <li>The Notice of Appeal was filed on A brief in comp filing the Notice of Appeal (37 CFR 41.37(a)), or any exter a Notice of Appeal has been filed, any reply must be filed AMENDMENTS</li> </ol>	nsion thereof (37 CFR 41.37(e)), to	o avoid dismissal of th	is of the date of e appeal. Since
3. The proposed amendment(s) filed after a final rejection, I	out prior to the date of filing a brief	will not be entered b	ecause
<ul> <li>(a) ☐ They raise new issues that would require further core</li> <li>(b) ☐ They raise the issue of new matter (see NOTE below)</li> <li>(c) ☐ They are not deemed to place the application in bet</li> </ul>	nsideration and/or search (see NC w);	TE below);	
appeal; and/or (d) ☐ They present additional claims without canceling a one NOTE: (See 37 CFR 1.116 and 41.33(a)).	corresponding number of finally re	jected claims.	
4. The amendments are not in compliance with 37 CFR 1.113	21 See attached Notice of Non-Co	ompliant Amendment	(PTOL-324)
5. Applicant's reply has overcome the following rejection(s)		ompliant / inchament	(1 102 02 1).
6. Newly proposed or amended claim(s) would be al non-allowable claim(s).	lowable if submitted in a separate		
7. For purposes of appeal, the proposed amendment(s): a) how the new or amended claims would be rejected is provided that the status of the claim(s) is (or will be) as follows: Claim(s) allowed: Claim(s) objected to: Claim(s) rejected: Claim(s) withdrawn from consideration:		ill be entered and an e	explanation of
AFFIDAVIT OR OTHER EVIDENCE			
8. The affidavit or other evidence filed after a final action, bu because applicant failed to provide a showing of good and was not earlier presented. See 37 CFR 1.116(e).	d sufficient reasons why the affida	vit or other evidence is	s necessary and
9. The affidavit or other evidence filed after the date of filing entered because the affidavit or other evidence failed to o showing a good and sufficient reasons why it is necessary	vercome <u>all</u> rejections under apper y and was not earlier presented. S	eal and/or appellant fa See 37 CFR 41.33(d)(	ils to provide a 1).
10. ☐ The affidavit or other evidence is entered. An explanation REQUEST FOR RECONSIDERATION/OTHER	n of the status of the claims after 6	entry is below or attact	iea.
11.  The request for reconsideration has been considered bu See Continuation Sheet.	t does NOT place the application i	in condition for allowa	nce because:
<ul><li>12. ☐ Note the attached Information Disclosure Statement(s).</li><li>13. ☐ Other:</li></ul>	(PTO/SB/08 or PTO-1449) Paper	No(s)	
10. [] Other			

Continuation of 11. does NOT place the application in condition for allowance because:

In response to Applicants' Request for Reconsideration, the arguments presented therein have been given further consideration. However, such arguments are found not to be persuasive for at least the following reasons:

The disclosed structure disclosed by Tsurishima et al (5227717) meet the conditions of disclosing all the claimed structural limitations

The disclosed structure disclosed by Tsurishima et al is capable of receiving semiconductor devices in the manner described in Applicants' claims

To clarify the relationship between the leadframe frame support member with respect to the positioning and placement of the semiconductor devices, the following explanation is provided:

Figures 5A, 5B and 6 are most pertinent and the interrelationship between them comprises a structure that meets the claimed limitations. Leadframe support member 24 includes carrier modules 22 as shown in Figure 6. Leadframe support member 24 also includes 4 vertical rows (configured as grooves) wherein the carrier modules 22 are positioned (Figure 6 only shows 3 modules for convenience of illustration however in an actual device a full number of carrier modules are installed; see column 10, lines 3-6). Therefore, the assembly shown in Figure 6 as a whole meets the structural limitations. With respect to the intended use of such an apparatus, attention is further drawn to Figures 5A and 5B wherein leads 46 of semiconductor ICs 44 are in contact with the surfaces of slits 102 to maintain fixed position of leads 46 for alignment of leads 46 during contact with test contactors 103 (shown in Figure 7B). This satisfies the intended use requirement for the leads extending from the devices and lying on a surface of the support member. Moreover, the grooves can accommodate a variety of semiconductor devices in various shapes and sizes (column 2, lines 59-61).

VINH NGUYÉN PRIMARY EXAMINER

A.u. 2829

02/14/06